

Low Loss IGBT : IGBT in TRENCHSTOP[™] and Fieldstop technology









Features:

- Very low V_{CE(sat)} 1.5V (typ.) •
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs •
- Designed for : •
 - Frequency Converters
 - Uninterrupted Power Supply
- TRENCHSTOP[™] and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
 - low V_{CE(sat)}
- Positive temperature coefficient in $V_{CE(sat)}$
- Low EMI •
- Low Gate Charge •
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant •
- Complete product spectrum and PSpice Models : http://www.infineon.com/igbt/

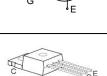
Туре	V _{CE}	I _C	V _{CE(sat),Tj=25℃}	T _{j,max}	Marking	Package
IGP50N60T	600 V	50 A	1.5 V	175 °C	G50T60	PG-TO220-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V
DC collector current, limited by T_{jmax}			
$T_{\rm C}$ = 25°C, value limited by bondwire	I _C	90	^
$T_{\rm C} = 100^{\circ}{\rm C}$		64	A
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	150	
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1\mu s$	-	150	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾	4	5	
$V_{\rm GE}$ = 15V, $V_{\rm CC} \le 400$ V, $T_{\rm j} \le 150^{\circ}$ C	t _{sc}	5	μs
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	333	W
Operating junction temperature	Tj	-40+175	
Storage temperature	T _{stg}	-55+150	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹ J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



PG-TO220-3



Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance,	R _{thJC}		0.45	K/W
junction – case				
Thermal resistance,	R _{thJA}		62	
junction - ambient				

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Devemeter	Sumbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 V, I_{\rm C} = 50 A$				
		T _j =25°C	-	1.5	2.0	
		<i>T</i> _j =175°C	-	1.9	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}=0.8$ mA, $V_{\rm CE}=V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		T _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	3500	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 \text{V}, V_{\rm GE} = 20 \text{V}$	-	-	100	nA
Transconductance	g fs	$V_{\rm CE} = 20 V, I_{\rm C} = 50 A$	-	31	-	S
Integrated gate resistor	R _{Gint}			-		Ω

Dynamic Characteristic

-						
Input capacitance	Ciss	V _{CE} =25V,	-	3140	-	pF
Output capacitance	Coss	$V_{\rm GE}=0V$,	-	200	-	
Reverse transfer capacitance	Crss	f=1MHz	-	93	-	
Gate charge	Q _{Gate}	$V_{\rm CC} = 480 \text{V}, I_{\rm C} = 50 \text{A}$	-	310	-	nC
		$V_{GE}=15V$				
Internal emitter inductance	LE	PG-TO-220-3-1	-	7	-	nH
measured 5mm (0.197 in.) from case		PG-TO-247-3-21	-	13	-	
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V,$	-	458.3	-	A
		$T_{\rm j} \leq 150^{\circ}{ m C}$				

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IGP50N60T

Switching Characteristic, Inductive Load, at $T_j=25$ °C

Parameter	Symbol	Conditions	Value			11
			min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_{j}=25^{\circ}C,$	-	26	-	ns
Rise time	t _r	V _{CC} =400V, I _C =50A, V _{GE} =0/15V, r _G =7Ω,	-	29	-	
Turn-off delay time	$t_{d(off)}$	L_{σ} =103nH, C_{σ} =39pF	-	299	-	
Fall time	t _f	L_{σ} , C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW50N60T	-	29	-	
Turn-on energy	Eon		-	1.2	-	mJ
Turn-off energy	E _{off}		-	1.4	-	
Total switching energy	Ets		-	2.6	-	

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Symbol	Conditions	Value			Unit
			min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	$T_{j}=175^{\circ}C,$	-	27	-	ns
Rise time	t _r	$V_{CC}=400V, I_{C}=50A,$ $V_{GE}=0/15V, r_{G}=7\Omega,$ $L_{\sigma}=103nH, C_{\sigma}=39pF$ L_{σ}, C_{σ} from Fig. E Energy losses include "tail" and diode reverse recovery. Diode from IKW50N60T	-	33	-	
Turn-off delay time	$t_{d(off)}$		-	341	-	
Fall time	t _f		-	55	-	
Turn-on energy	Eon		-	1.8	-	mJ
Turn-off energy	E _{off}		-	1.8	-	
Total switching energy	Ets		-	3.6	-	

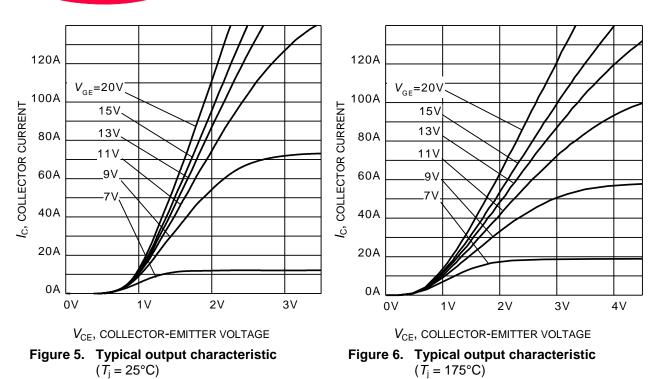


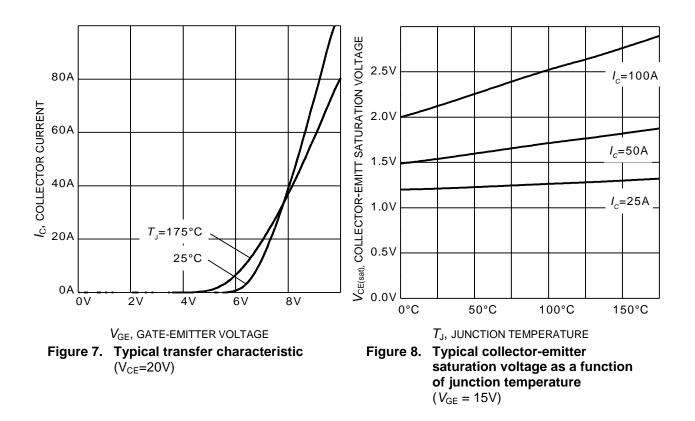
IGP50N60T

=2115 140A 100A 120A *l*_c, COLLECTOR CURRENT 909 V 00 V V V V V 10µs (c, COLLECTOR CURRENT =80°C 7 10A 50µs $T_c = 110^{\circ}C$ I_c Ħ 1ms ш 20A l_c 1A DC 10ms 0A 100Hz 1kHz 10kHz 100kHz 1V 10V 100V 1000V f, SWITCHING FREQUENCY V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 1. Collector current as a function of Figure 2. Safe operating area switching frequency $(D = 0, T_{\rm C} = 25^{\circ}{\rm C}, T_{\rm i} \le 175^{\circ}{\rm C};$ $({\it T}_i \le 175^{\circ}C, \ {\it D}=0.5, \ {\it V}_{CE}=400V,$ $V_{GE} = 0/15V$ $V_{\rm GE} = 0/15 {\rm V}, r_{\rm G} = 7 {\Omega}$ 90A 300W 80A 70A POWER DISSIPATION 250W COLLECTOR CURRENT 60A 200W 50A 150W 40A 30A ۇ 100W Ú, 20A 50W 10A I_{cmax} max. current limited by bondwire 0A 0₩<u></u> 25°C 75°C 100°C 125°C 150°C 50°C 75°C 100°C 125°C 150°C 25°C 50°C $T_{\rm C}$, CASE TEMPERATURE $T_{\rm C}$, CASE TEMPERATURE Figure 3. Power dissipation as a function Figure 4. Collector current as a function of of case temperature case temperature $(T_{i} \le 175^{\circ}C)$ $(V_{GE} \ge 15V, T_j \le 175^{\circ}C)$



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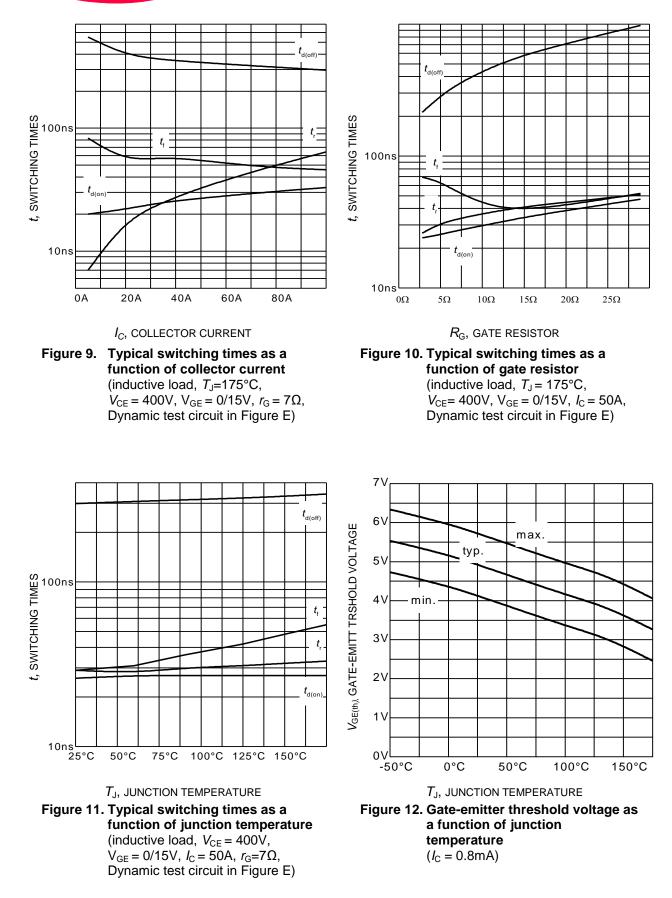






IGP50N60T

TRENCHSTOP™ Series





IGP50N60T TRENCHSTOP[™] Series

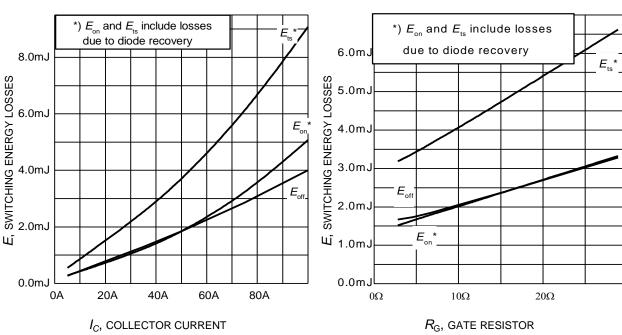
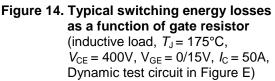
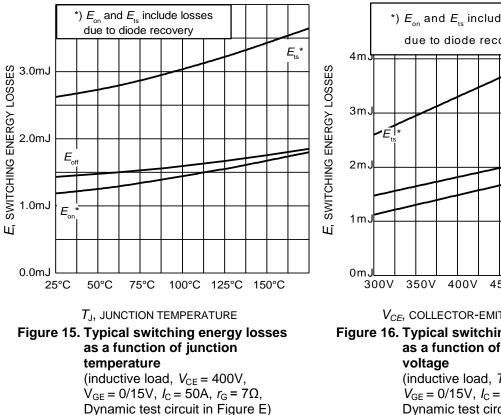
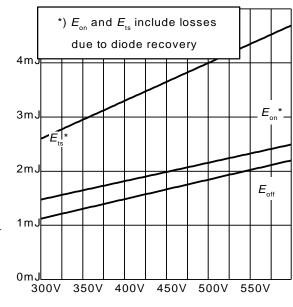


Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_J = 175^{\circ}C$, $V_{\rm CE} = 400$ V, $V_{\rm GE} = 0/15$ V, $r_{\rm G} = 7\Omega$, Dynamic test circuit in Figure E)



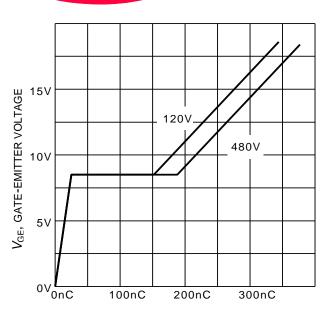




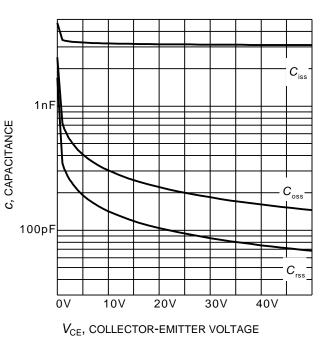
 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 16. Typical switching energy losses as a function of collector emitter (inductive load, $T_J = 175^{\circ}$ C,

 $V_{\rm GE} = 0/15 \text{V}, I_{\rm C} = 50 \text{A}, r_{\rm G} = 7 \Omega,$ Dynamic test circuit in Figure E)



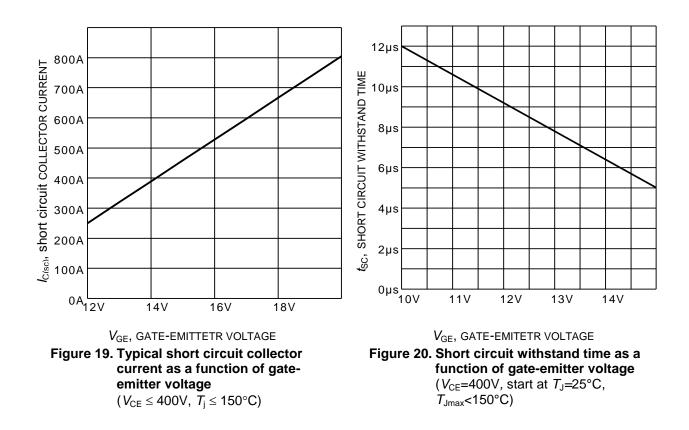


 Q_{GE} , GATE CHARGE Figure 17. Typical gate charge $(I_C=50 \text{ A})$

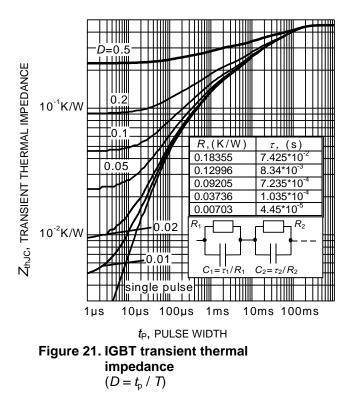


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Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f = 1 \text{ MHz})$



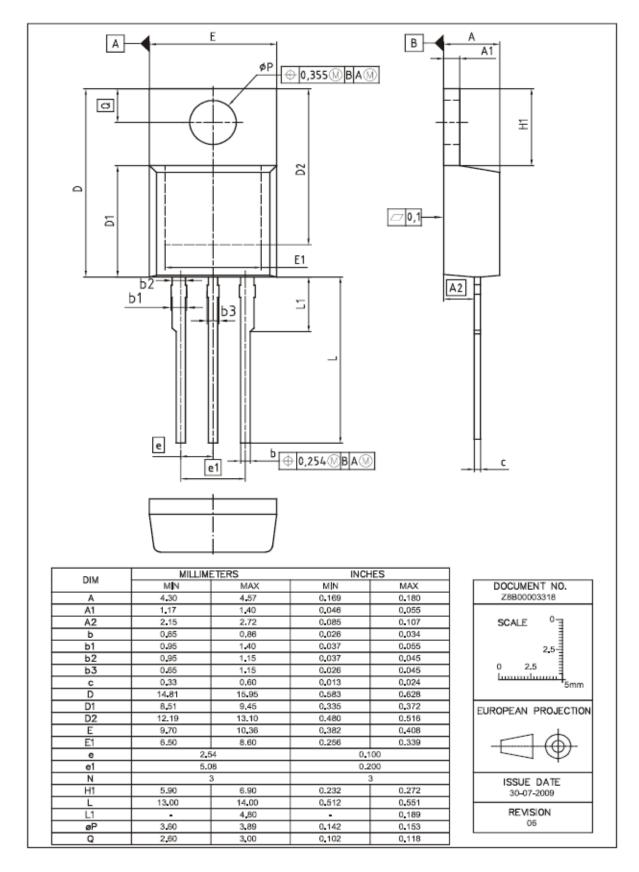






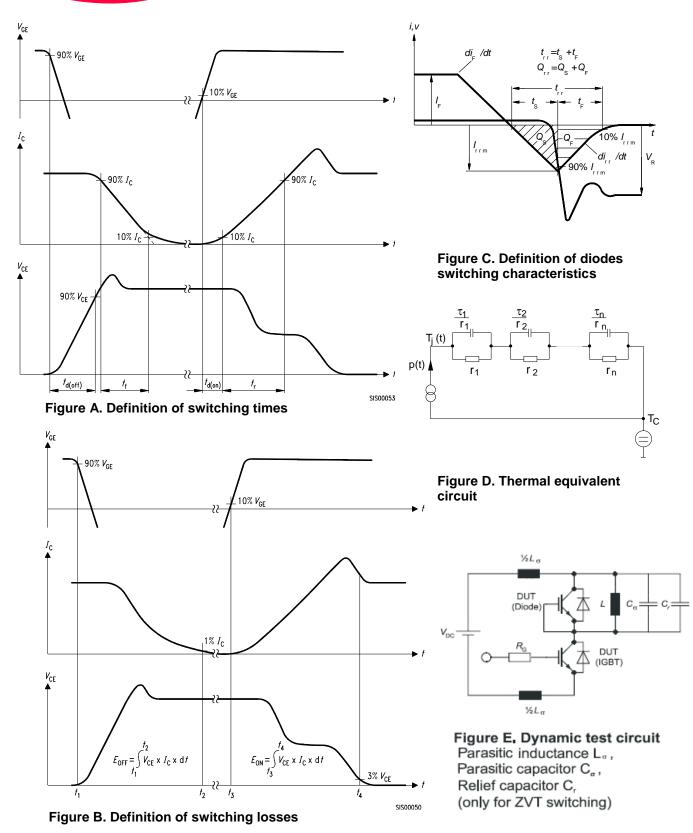
TRENCHSTOP[™] Series

PG-TO220-3





IGP50N60T





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